### 1 Appearance

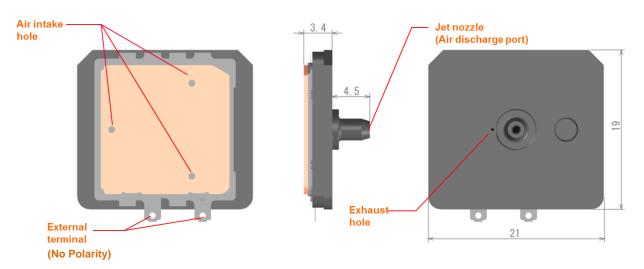


Table.1-1

| Item                     | Specification | Condition             |
|--------------------------|---------------|-----------------------|
| Outside dimension/toler- | 21±0.2mm      |                       |
| ance                     | 19±0.2mm      | Except the terminal   |
| Thickness/tolerance      | 3.4±0.2mm     | Except the Jet nozzle |

# 2 Ratings

### Table.2-1

| Rating                                    | Value          | Unit | Condition            |
|---|----------------|------|----------------------|
| Operating Voltage Range                   | 8 to 18 ※1-1   | Vdc  | Back pressure <10kPa |
| Operating voltage Kange                   | 8 to 19.5 ※1-1 | Vdc  | Back pressure ≧10kPa |
| Environmental Operating Temperature Range | 0 to +45       | °C   | -                    |

### ¾1-1 Voltage to be applied to recommended driver circuit.

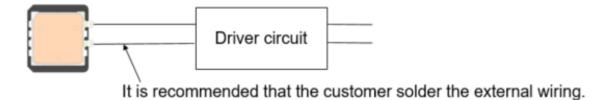
Less than 8Vdc driving may be occurred oscillation failure.

The pump can be driven by a voltage of 18 Vdc or more, only in the case where the back pressure is +10 kPa.

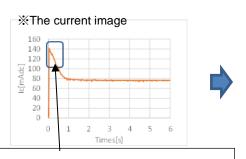
If the back pressure is less than +10 kPa, and in addition the pump is driven by a voltage of 18 Vdc or more, there is a possibility of a breakdown occurring.

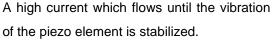
## X1-2 Pump's performance may decrease by self heating.

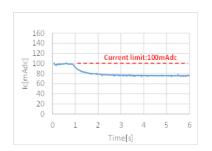
Please use it in its metal surface temperature less than or equal to 60°C.



※2 When a current exceeding 100(mA) flows through the circuit, the pump may be damaged, so pay attention when designing the circuit. At the start of driving, high current may flow until the vibration of the piezo element is stabilized.

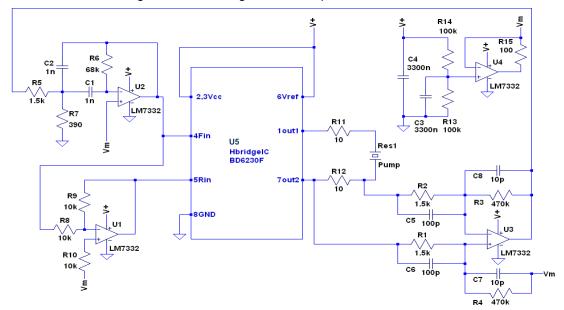






The circuit current should not exceed 100 mA

Murata uses the following driver circuit to guarantee air performance.





# BOM

| Reference | PartsCategory | PartsName  | VendorName | Value   | Tolerance | Rating |
|-----------|---------------|------------|------------|---------|-----------|--------|
| U1        | Opamp IC      | LM7332     | TI         | _       | _         | -      |
| U2        | Opamp IC      | LM7332     | TI         | _       | _         | -      |
| U3        | Opamp IC      | LM7332     | TI         | _       | _         | -      |
| U4        | Opamp IC      | LM7332     | TI         | -       | _         | -      |
| U5        | H-Bridge IC   | BD6230F-E2 | ROHM       | _       | _         | -      |
| R1        | Resistor      |            |            | 1.5kohm | ±1%       | 0.1W   |
| R2        | Resistor      |            |            | 1.5kohm | ±1%       | 0.1W   |
| R3        | Resistor      |            |            | 470kohm | ±1%       | 0.1W   |
| R4        | Resistor      |            |            | 470kohm | ±1%       | 0.1W   |
| R5        | Resistor      |            |            | 1.5kohm | ±1%       | 0.1W   |
| R6        | Resistor      |            |            | 68kohm  | ±1%       | 0.1W   |
| R7        | Resistor      |            |            | 390ohm  | ±1%       | 0.1W   |
| R8        | Resistor      |            |            | 10kohm  | ±1%       | 0.1W   |
| R9        | Resistor      |            |            | 10kohm  | ±1%       | 0.1W   |
| R10       | Resistor      |            |            | 10kohm  | ±1%       | 0.1W   |
| R11       | Resistor      |            |            | 10ohm   | ±1%       | 0.25W  |
| R12       | Resistor      |            |            | 10ohm   | ±1%       | 0.25W  |
| R13       | Resistor      |            |            | 100kohm | ±1%       | 0.1W   |
| R14       | Resistor      |            |            | 100kohm | ±1%       | 0.1W   |
| R15       | Resistor      |            |            | 100ohm  | ±1%       | 0.1W   |
| C1        | Capacitor     |            |            | 1000pF  | ±5%       | 50Vdc  |
| C2        | Capacitor     |            |            | 1000pF  | ±5%       | 50Vdc  |
| C3        | Capacitor     |            |            | 3.3uF   | ±10%      | 50Vdc  |
| C4        | Capacitor     |            |            | 3.3uF   | ±10%      | 50Vdc  |
| C5        | Capacitor     |            |            | 100pF   | ±5%       | 50Vdc  |
| C6        | Capacitor     |            |            | 100pF   | ±5%       | 50Vdc  |
| C7        | Capacitor     |            |            | 10pF    | ±5%       | 50Vdc  |
| C8        | Capacitor     |            |            | 10pF    | ±5%       | 50Vdc  |



### 3 Performance

### 3.1 Air Performance

Table. 3-1

| Item                      | Specification | Condition   |
|---------------------------|---------------|---|
| Free Flow Rate<br>@18Vdc  | ≧155ml/min    | Ambient temperature:18 to 28°C Relative humidity: 25 to 85%RH |
| Static Pressure<br>@21Vdc | ≧50kPa        | Atomspsheric pressure: 950 to 1020 hPa                        |

### 3.2 Electrical Performance

Table. 3-2

| Item           | Specification | Condition |
|----------------|---------------|-----------|
| Drive Resonant | 21.5 to       |           |
| Frequency      | 24.5kHz       |           |

#### Note:

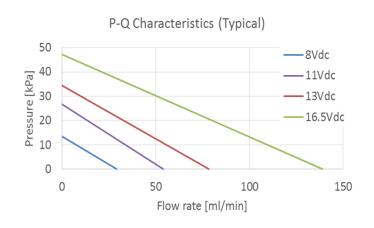
This catalog is for reference only and not an official product specification document, therefore, please review and approve our official product specification before ordering this product.



## 4 Typical Characteristic \* 4-1

Table, 4-1

| Item  |           |
|---|-----------|
| Free Flow Rate (0kPa) @18Vdc                | 200ml/min |
| Power consumption @Free Flow Rate 18Vdc     | 0.9W      |
| Static Pressure (0ml/min)<br>@19.5Vdc       | 60kPa     |
| Power consumption  @Static Pressure 19.5Vdc | 1.2W      |
| Exhaust time ※4-2                           | ≦10sec    |
| Drive Resonant<br>Frequency                 | 23kHz     |



\*4-1 There are not guaranteed values.

\*\*4-2Time during which the pressure in the 100cc tank connected to MZB3004T04 which is connected to 100cc tank falls from 260mmHg to 15mmHg when the MZB3004T04 is turned off.

In all cases, the following measures should be taken to ensure the safety of the product.

- ① Installation of protection circuits or other protective device to improve system safety
- ② Installation of redundant circuits in the case of single-circuit failure



### 5 Test Result

XThe following test results are only experimental results and are not guaranteed.

## 5.1 Physical Stress Test

Table. 5-1

| Item   | Test Condition   | Number                | Result |
|--|--|-----------------------|--------|
| Vibration  | Applying the vibration of maximum amplitude 1.5mm and vibration frequency 10 to 55Hz/10G in each of 3 perpendicular directions for 11min x 24 times.   | 10                    | G      |
| Shock  | 100G/6msec,<br>Applying the shock of 100G 3 times for six aspects.   | 10                    | G      |
| Free Drop  | 75 cm height, wood floor, 3 times  | 10                    | G      |
| Outer Terminal<br>Strength<br>(1)Pull<br>(2)Bend | (1) Pull  Test force 5N, tensile direction is horizontal direction for terminal,time-of-stressing 10 seconds  (2) Bend Test force 2.5N, bending direction is vertical direction for terminal,time-of-stressing 2-3 seconds | Each di-<br>rection 5 | G      |

## Judgement condition:

After test, characteristics of table 3-1 and table 3-2 are within spec or variation in the characteristics is within 15%

## 5.2 Strage Test

Table. 5-2

| Item                | Test Condition   | Number | Result |
|---------------------|--|--------|--------|
| Cold                | Pump shall be left in a chamber (Temperature:-40±2°C) for 500 hours, then measured after leaving in natural condition for 2 hours.               | 10     | G      |
| Dry Heat            | Pump shall be left in a chamber (Temperature:+70±2°C,65±5%RH) for 500 hours, then measured after leaving in natural condition for 2 hours.       | 10     | G      |
| Humidity            | Pump shall be left in a chamber (95±5%R.H.at +50±2°C) for 500 hours, then measured after leaving in natural condition for 2 hour.                | 10     | G      |
| Thermal schock test | Test temperature -25±3 °C / 60±2 °C, Test time 30 min/, 30 min, 500 cycles tested, then measured after leaving in natural condition for 2 hours. | 10     | G      |

Note) At Murata test condition

### Judgement condition:

After test, characteristics of table 3-1 and table 3-2 are within spec or variation in the characteristics is within 15%.

## 5.3 Driving Test

Table. 5-3

| Item                         | Test Condition  | Number | Result |
|------------------------------|---|--------|--------|
| Continuous Driving<br>Test 1 | Drive Voltage:16.5Vdc Drive mode:Pressure mode (Closed space) In crean room Driving period:500hr Environmental temperature:Room temperature | 10     | G      |
| Continuous Driving<br>Test 2 | Drive Voltage:16.5Vdc Drive mode:Flow mode (Opened space) In crean room Driving period:500hr Environmental temperature:Room temperature     | 10     | G      |

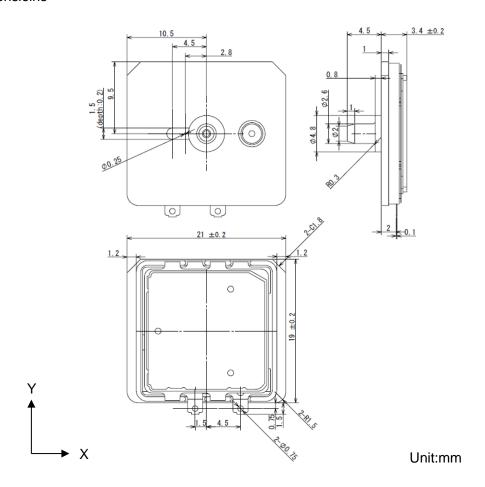
## Note) At Murata test condition

The metal surface temperature of the products was 60  $^{\circ}$  C or less when driven under the above conditions.

### Judgement condition:

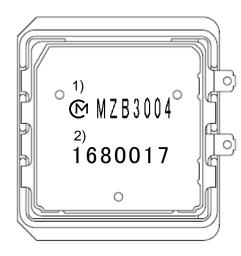
After test, characteristics of table 3-1 and table 3-2 are within spec or variation in the characteristics is within 15%.

## 6 Dimensioins



\* The dimensions without tolerances shown in the following figure are reference values.

### 7 Printing



1. Company symbol ( M) and Parts number: MZB3004

2. Lot no.: 7 letters

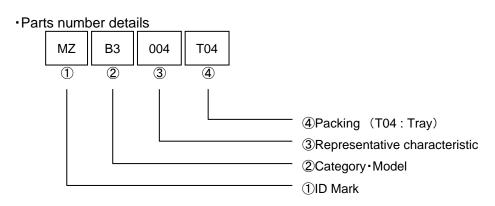
(1) Year: the last 2 digits of the year(2) Month: 1~9, X:Oct., Y:Nov., Z:Dec.

(3) Lot No: 0001~9999

The serial number each lot

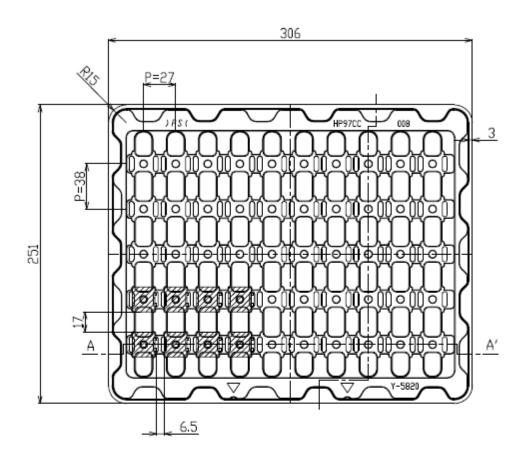
Ex.) 2016. August lot

Laser marking above letters





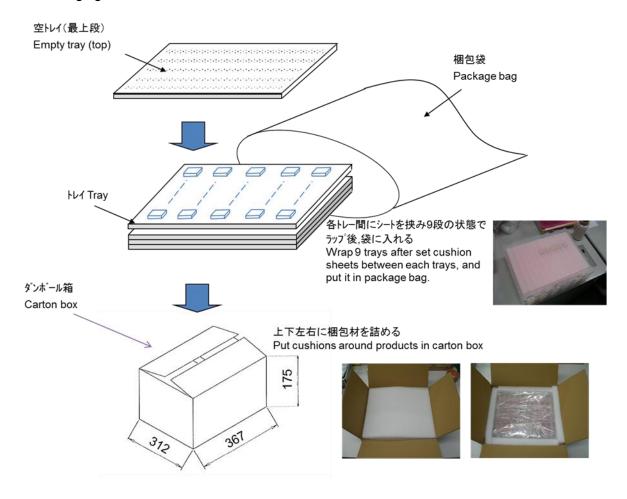
- 8 Packing Standard8.1 Dimensions of Tray







### 8.2 Packaging Form



### 8.3 The Quantity per a box

Packaging Quantity: 400 pieces max. (= 50 pieces /tray x 8 trays)

However, total number of tray is 9 trays because empty tray is set on the top

Maximum 3 Lot mix/carton box

### 8.4 Content of Outer Label

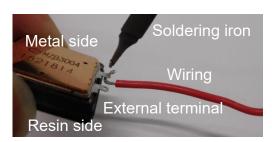
The minimum packaging unit shall be a box. Each minimum package unit of pumps shall be in a carton box and it shall be clearly marked with your company name, customer's and Murata's part numbers, quantity and so on.



### 9. Considerations for soldering

## 9.1 Wiring

Lead wire should be through from back side terminal hole to top side. And soldering is enough to treat top side only.



## 9-2. Condition for soldering

Please solder the sample by using the soldering iron, and please don't touch the housing directly.

**Soldering Conditions** 

| Temperature of iron | ≦350°C                                       |
|---------------------|--|
| Contact time        | ≦3Sec / each terminal                        |
| Note                | less than 3 cycle ( 350°C,3sec(max.) /cycle) |

## Note) Please careful excessive terminal bent.

To avoid trouble, please keep bending force to terminal 2.5N or less.



# 10. A Cautions

### 10-1 Limitation of applications

The products are designed and produced for application in ordinary electronic equipment (AV equipment, OA equipment, telecommunication, etc). If the products are to be used in devices requiring extremely high reliability following the application listed below, you should consult with the Murata staff in advance.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment.
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-procession equipment.
- Application which malfunction or operational error may endanger human life and property of assets.
- Application which related to occurrence the serious damage
- Application of similar complexity and/ or reliability requirements to the applications listed in the above.

#### 10-2 Fail-safe

If product malfunctions may result in serious damage, including that to human life, sufficient failsafe measures must be taken, including the following:

- (1) Installation of protection circuits or other protective device to improve system safety
- (2) Installation of redundant circuits in the case of single-circuit failure

### 11 Instruction for use

- 11-1. Since the product sucks and dischages air, contaminants and dust in the air tend to accmulate inside the pump, and the contaminants and dust will influence the operation time. Use the product in a clean environment, or use a filter to remove at least submicron level of contaminants to prevent particles and dust from entering. (\*The use of filter does not guarantee suppression of the characteristics deterioration of the product.) Our company doesn't bear any responsibility with respect to the problems.
- 11.2 Please do not touch the component (included nozzle, Outer terminal.) with bare hands.
- 11.3 Applying load on the product during operation may cause characteristics drop or sound noise generation. And more, when you push the center of a body temporarily at the time of assembly, etc., please do not apply load more than 1kgf (10N).
- 11.4 Please refrain from using the product under the condensation environment.
- 11.5 When the drive of the product is stopped while it is connected to it with the container of 10cc or less, the noisy may occur. But it isn't a defect.
- 11.6 Please pay attention to protect operating circuit from surge voltage provided by something
- 11.7 Please pay attention never to apply DC voltage and over 100mA current to the product.
- 11.8 Washing of the component is not acceptable, because it is not sealed.
- 11.9 Automatic mounting (SMT) is not acceptable.
- 11.10 No effect for the performance even if there are scratches on appearance and tarnishes of material.
- 11.11 Please take electrostatic countermeasure with wrist band etc.



- 12 Notice on Storage
- 12.1 Please store the products in room where the temperature/humidity is stable. And avoid such places where there are large temperature changes. Please store the products.

Under the following conditions : Temperature -10 to +40 deg

Humidity 10 to 85% RH

- 12.2 Expire date (Shelf life) of the products is 6 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 6 months after delivery. If you store the products for a long time (more than 6months), use carefully because the products may be degraded in the solder-ability and/or rusty. Please confirm solder-ability and char acteristics for the products regularly
- 12.3 Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solder-ability due to the storage in a chemical atmosphere.
- 12.4 Please do not put the products directly on the floor without anything under them to avoid damp places and/or dusty places
- 12.5 Please do not store the products in the places such as : in a damp heated place, in a place where direct sunlight comes in, in place applying vibrations.
- 12.6 Please use the products immediately after the package is opened, because the characteris tics may be reduced in quality, and/or be degraded in the solder-ability due to storage under the poor condition.
- 12.7 Please do not drop products to avoid cracking of ceramic element.



### 13 Note

- 13.1 Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 13.2 Product specifications are subject to change or our products in it may be discontinued without advance notice.
- 13.3 This catalog is for reference only and not an official product specification document, therefore, please review and approve our official product specification before ordering this product